

# 2SB0873 (2SB873)

## Silicon PNP epitaxial planar type

For low-frequency power amplification

For DC-DC converter

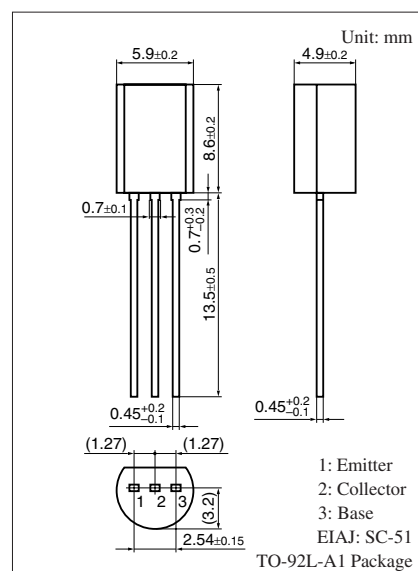
For stroboscope

### ■ Features

- Low collector-emitter saturation voltage  $V_{CE(sat)}$
- Large collector current  $I_C$

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter                             | Symbol    | Rating      | Unit             |
|---------------------------------------|-----------|-------------|------------------|
| Collector-base voltage (Emitter open) | $V_{CBO}$ | -30         | V                |
| Collector-emitter voltage (Base open) | $V_{CEO}$ | -20         | V                |
| Emitter-base voltage (Collector open) | $V_{EBO}$ | -7          | V                |
| Collector current                     | $I_C$     | -5          | A                |
| Peak collector current                | $I_{CP}$  | -10         | A                |
| Collector power dissipation           | $P_C$     | 1           | W                |
| Junction temperature                  | $T_j$     | 150         | $^\circ\text{C}$ |
| Storage temperature                   | $T_{stg}$ | -55 to +150 | $^\circ\text{C}$ |



### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

| Parameter                                                      | Symbol        | Conditions                                                        | Min | Typ | Max  | Unit |
|----------------------------------------------------------------|---------------|-------------------------------------------------------------------|-----|-----|------|------|
| Collector-emitter voltage (Base open)                          | $V_{CEO}$     | $I_C = -1 \text{ mA}, I_B = 0$                                    | -20 |     |      | V    |
| Emitter-base voltage (Collector open)                          | $V_{EBO}$     | $I_E = -10 \mu\text{A}, I_C = 0$                                  | -7  |     |      | V    |
| Collector-base cutoff current (Emitter open)                   | $I_{CBO}$     | $V_{CB} = -10 \text{ V}, I_E = 0$                                 |     |     | -100 | nA   |
| Emitter-base cutoff current (Collector open)                   | $I_{EBO}$     | $V_{EB} = -5 \text{ V}, I_C = 0$                                  |     |     | -100 | nA   |
| Forward current transfer ratio *1, 2                           | $h_{FE}$      | $V_{CE} = -2 \text{ V}, I_C = -2 \text{ A}$                       | 90  |     | 625  | —    |
| Collector-emitter saturation voltage *1                        | $V_{CE(sat)}$ | $I_C = -3 \text{ A}, I_B = -0.1 \text{ A}$                        |     |     | -1   | V    |
| Transition frequency                                           | $f_T$         | $V_{CB} = -6 \text{ V}, I_E = 50 \text{ mA}, f = 200 \text{ MHz}$ |     | 120 |      | MHz  |
| Collector output capacitance (Common-emitter reverse transfer) | $C_{ob}$      | $V_{CB} = -20 \text{ V}, I_E = 0, f = 1 \text{ MHz}$              |     |     | 85   | pF   |

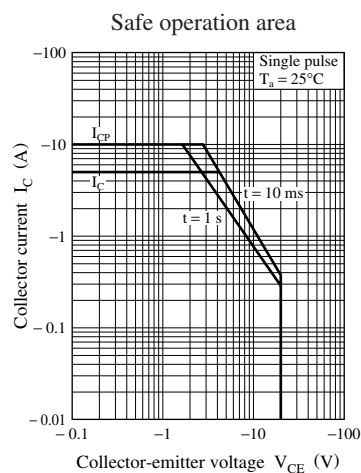
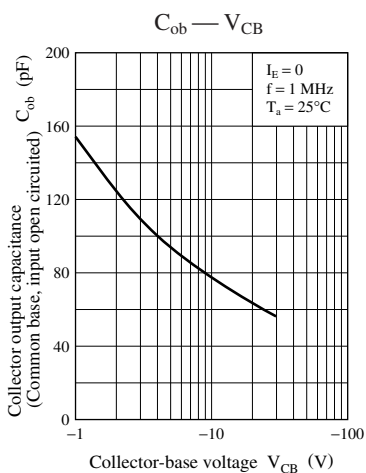
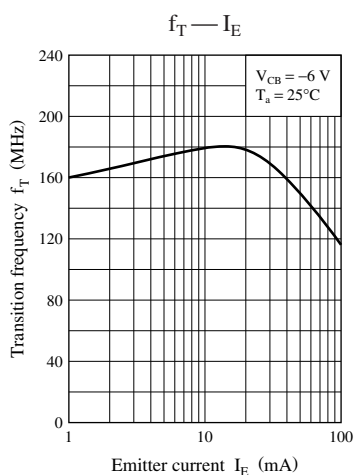
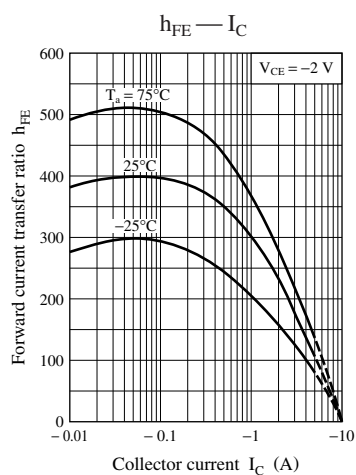
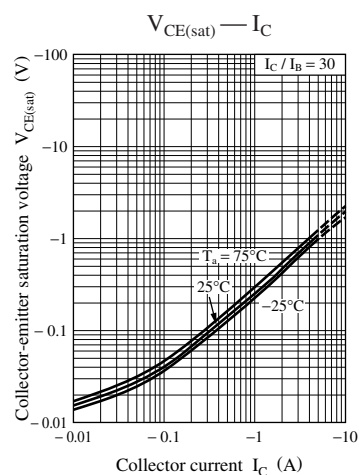
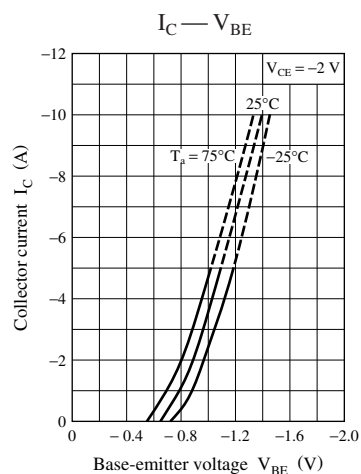
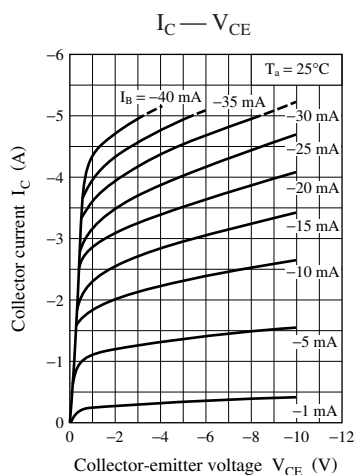
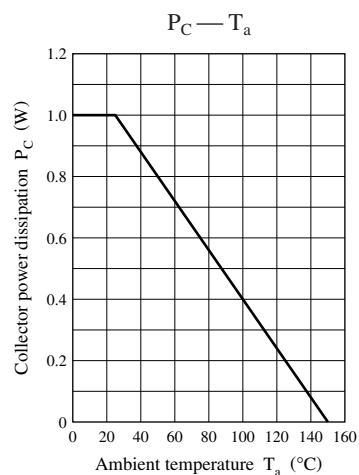
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*1: Pulse measurement

\*2: Rank classification

| Rank     | P         | Q          | R          |
|----------|-----------|------------|------------|
| $h_{FE}$ | 90 to 135 | 120 to 205 | 180 to 625 |

Note) The part number in the parenthesis shows conventional part number.



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